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OCT 21 2005

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In Re Application of:)

Applicants : MOU-SHIUNG LIN ET AL.)

Examiner: MITCHELL, JAMES M

Serial No.: 10/055,568)

Art Unit: 2813

Filed: 01/22/2002)

Docket No.: MEGP0004USA

For: INTEGRATED CHIP PACKAGE)
STRUCTURE USING SILICON)
SUBSTRATE AND METHOD OF)
MANUFACTURING THE SAME)AMENDMENT AND RESPONSE TO OFFICE ACTIONCommissioner for Patents
P. O. Box 1450
Alexandria, VA 22313-1450

Dear Sir:

The Office Action mailed September 20, 2005 has been carefully considered. In response thereto, please enter the following amendments and consider the following remarks.